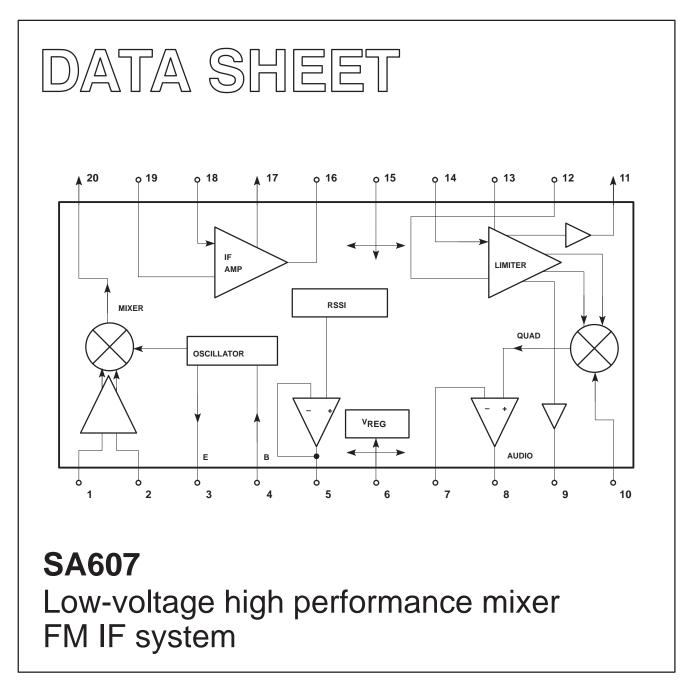
### **RF COMMUNICATIONS PRODUCTS**



Product specification Replaces data of November 3, 1992 IC17 Data Handbook

1997 Nov 07

# **Philips Semiconductors**





**SA607** 

#### DESCRIPTION

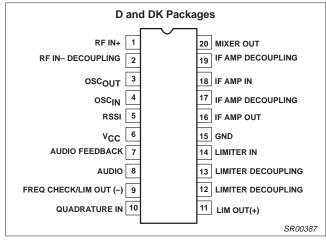
The SA607 is a low voltage high performance monolithic FM IF system incorporating a mixer/oscillator, two limiting intermediate frequency amplifiers, quadrature detector, logarithmic received signal strength indicator (RSSI), voltage regulator and audio and RSSI op amps. The SA607 is available in 20-lead SOL (surface-mounted miniature package) and 20-lead SSOP package.

The SA607 was designed for portable communication applications and will function down to 2.7V. The RF section is similar to the famous SA605. The audio output has an internal amplifier with the feedback pin accessible. The RSSI output is buffered. The SA607 also has an extra limiter output. This signal is buffered from the output of the limiter and can be used to perform frequency check. This is accomplished by comparing a reference frequency with the frequency check signal using a comparator to a varactor or PLL at the oscillator inputs.

#### **FEATURES**

- Low power consumption: 3.5mA typical at 3V
- Mixer input to >150MHz
- Mixer conversion power gain of 17dB at 45MHz
- XTAL oscillator effective to 150MHz (L.C. oscillator or external oscillator can be used at higher frequencies)
- 102dB of IF Amp/Limiter gain
- 2MHz limiter small signal bandwidth
- Temperature compensated logarithmic Received Signal Strength Indicator (RSSI) with a 90dB dynamic range
- Low external component count; suitable for crystal/ceramic/LC filters
- Excellent sensitivity: 0.31μV into 50Ω matching network for 12dB SINAD (Signal to Noise and Distortion ratio) for 1kHz tone, 8kHz deviation with RF at 45MHz and IF at 455kHz
- SA607 meets cellular radio specifications
- Audio output internal op amp
- RSSI output internal op amp

#### **PIN CONFIGURATION**



#### Figure 1. Pin Configuration

- Buffered frequency check output
- Internal op amps with rail-to-rail outputs
- ESD protection: Human Body Model 2kV Robot Model 200V

#### **APPLICATIONS**

- Portable cellular radio FM IF
- Cordless phones
- Narrow band cellular applications (NAMPS/NTACS)
- RF level meter
- Spectrum analyzer
- Instrumentation
- FSK and ASK data receivers
- Log amps
- Portable high performance communication receivers
- Single conversion VHF receivers
- Wireless systems

#### **ORDERING INFORMATION**

DESCRIPTION	TEMPERATURE RANGE	ORDER CODE	DWG #
20-Pin Plastic Small Outline Large (SOL) package (Surface-mount)	-40 to +85°C	SA607D	SOT163-1
20-Pin Plastic Shirnk Small Outline Package (SSOP) (Surface-mount)	-40 to +85°C	SA607DK	SOT266-1

SA607

### **BLOCK DIAGRAM**

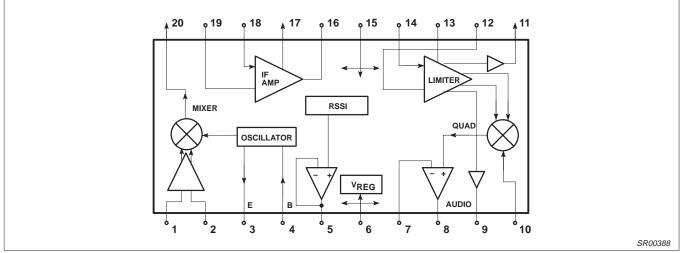


Figure 2. Block Diagram

#### **ABSOLUTE MAXIMUM RATINGS**

SYMBOL	PARAMETER	RATING	UNITS
V <sub>CC</sub>	Single supply voltage	7	V
T <sub>STG</sub>	Storage temperature range	-65 to +150	°C
T <sub>A</sub>	Operating ambient temperature range SA607	-40 to +85	°C
$\theta_{JA}$	Thermal impedance D package DK package	90 117	°C/W

### DC ELECTRICAL CHARACTERISTICS

 $V_{CC}$  = +3V,  $\ T_A$  = 25  $^{\circ}C;$  unless otherwise stated.

SYMBOL	PARAMETER	TEST CONDITIONS		UNITS		
			MIN	TYP	MAX	
V <sub>CC</sub>	Power supply voltage range		2.7		7.0	V
I <sub>CC</sub>	DC current drain			3.5	4.2	mA

SA607

#### AC ELECTRICAL CHARACTERISTICS

 $T_A = 25^{\circ}C$ ;  $V_{CC} = +3V$ , unless otherwise stated. RF frequency = 45MHz + 14.5dBV RF input step-up; IF frequency = 455kHz; R17 = 2.4k; R18 = 3.3k; RF level = -45dBm; FM modulation = 1kHz with  $\pm 8kHz$  peak deviation. Audio output with de-emphasis filter and C-message weighted filter. Test circuit 3. The parameters listed below are tested using automatic test equipment to assure consistent electrical characterristics. The limits do not represent the ultimate performance limits of the device. Use of an optimized RF layout will improve many of the listed parameters.

SYMBOL				LIMITS				
	PARAMETER	TEST CONDITIONS		UNITS				
			MIN	TYP	MAX			
Mixer/Osc	section (ext LO = 220mV <sub>RMS</sub> )	•	•		•			
f <sub>IN</sub>	Input signal frequency			150		MHz		
fosc	Crystal oscillator frequency			150		MHz		
	Noise figure at 45MHz			6.2		dB		
	Third–order input intercept point (50 $\Omega$ source)	f1 = 45.0; f2 = 45.06MHz Input RF Level = -52dBm		-9		dBm		
	Conversion power gain	Matched 14.5dBV step-up	13.5	17	19.5	dB		
		50Ω source		+2.5		dB		
	RF input resistance	Single-ended input		8		kΩ		
	RF input capacitance			3.0	4.0	pF		
	Mixer output resistance	(Pin 20)	1.25	1.5		kΩ		
IF section	•	•	•					
	IF amp gain	50Ω source		44		dB		
	Limiter gain	50Ω source		58		dB		
	Input limiting –3dB, R <sub>17</sub> = 2.4k	Test at Pin 18		-109		dBm		
	AM rejection	80% AM 1kHz		45		dB		
	Audio level	Gain of two (2kΩ AC load)	70	120	160	mV		
	SINAD sensitivity	RF level –110dB		17		dB		
THD	Total harmonic distortion		-35	-50		dB		
S/N	Signal-to-noise ratio	No modulation for noise		62		dB		
	IF RSSI output, $R_9 = 2k\Omega^1$	IF level = -118dBm		0.3	0.8	V		
		IF level = -68dBm	.70	1.1	1.80	V		
		IF level = -23dBm	1.2	1.8	2.5	V		
	RSSI range			90		dB		
	RSSI accuracy			<u>+</u> 1.5		dB		
	IF input impedance		1.3	1.5		kΩ		
	IF output impedance			0.3		kΩ		
	Limiter input impedance		1.30	1.5		kΩ		
	Limiter output impedance	(Pin 11)		200		Ω		
	Limiter output level	(Pin 11) No load 5kΩ load		130 115		mV <sub>RM</sub>		
	Frequency check/limiter output impedance	(Pin 9)		200		Ω		
	Frequency check/limiter output level	(Pin 9) No load 5kΩ load		130 115		mV <sub>RM</sub>		
RF/IF section	on (int LO)							
	Audio level	$3V = V_{CC}$ , RF level = $-27$ dBm		120		mV <sub>RM</sub>		
	System RSSI output	$3V = V_{CC}$ , RF level = $-27$ dBm		2.2		V		
	System SINAD sensitivity	RF level = -117dBm		12		dB		

NOTE:

1. The generator source impedance is 50Ω, but the SA607 input impedance at Pin 18 is 1500Ω. As a result, IF level refers to the actual signal that enters the SA607 input (Pin 18) which is about 21dB less than the "available power" at the generator.

SA607

#### **CIRCUIT DESCRIPTION**

The SA607 is an IF signal processing system suitable for second IF systems with input frequency as high as 150MHz. The bandwidth of the IF amplifier and limiter is at least 2MHz with 90dB of gain. The gain/bandwidth distribution is optimized for 455kHz,  $1.5k\Omega$  source applications. The overall system is well-suited to battery operation as well as high performance and high quality products of all types.

The input stage is a Gilbert cell mixer with oscillator. Typical mixer characteristics include a noise figure of 6.2dB, conversion gain of 17dB, and input third-order intercept of –9dBm. The oscillator will operate in excess of 200MHz in L/C tank configurations. Hartley or Colpitts circuits can be used up to 100MHz for xtal configurations. Butler oscillators are recommended for xtal configurations up to 150MHz.

The output impedance of the mixer is a  $1.5k\Omega$  resistor permitting direct connection to a 455kHz ceramic filter. The input resistance of the limiting IF amplifiers is also  $1.5k\Omega$ . With most 455kHz ceramic filters and many crystal filters, no impedance matching network is necessary. The IF amplifier has 43dB of gain and 5.5MHz bandwidth. The IF limiter has 60dB of gain and 4.5MHz bandwidth. To achieve optimum linearity of the log signal strength indicator, there must be a 12dB(v) insertion loss between the first and second IF stages. If the IF filter or interstage network does not cause 12dB(v) insertion loss, a fixed or variable resistor or an L pad for simultaneous loss and impedance matching can be added between the first IF output (Pin 16) and the interstage network. The overall gain will then be 90dB with 2MHz bandwidth.

The signal from the second limiting amplifier goes to a Gilbert cell quadrature detector. One port of the Gilbert cell is internally driven by the IF. The other output of the IF is AC-coupled to a tuned quadrature network. This signal, which now has a  $90^{\circ}$  phase relationship to the internal signal, drives the other port of the multiplier cell.

The demodulated output of the quadrature drives an internal op amp. This op amp can be configured as a unity gain buffer, or for simultaneous gain, filtering, and 2nd-order temperature compensation if needed. It can drive an AC load as low as  $5k\Omega$  with a rail-to-rail output.

A log signal strength completes the circuitry. The output range is greater than 90dB and is temperature compensated. This log signal strength indicator exceeds the criteria for AMPs or TACs cellular telephone. This signal is buffered through an internal unity gain op amp. The frequency check pin provides a buffered limiter output. This is useful for implementing an AFC (Automatic Frequency Check) function. This same output can also be used in conjunction with limiter output (Pin 11) for demodulating FSK (Frequency Shift Keying) data. Both pins are of the same amplitude, but 180° out of phase.

NOTE: Limiter output or Frequency Check output has drive capability of a load minimum of  $2k\Omega$  or higher to obtain 115mV output level.

NOTE:  $dB(v) = 20 \log V_{OUT}/V_{IN}$ 

SA607

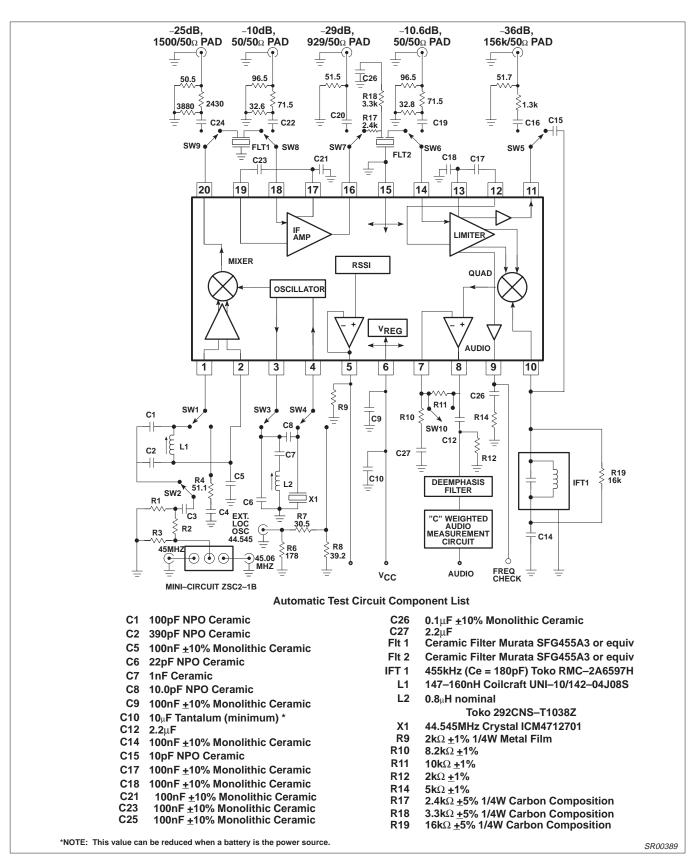
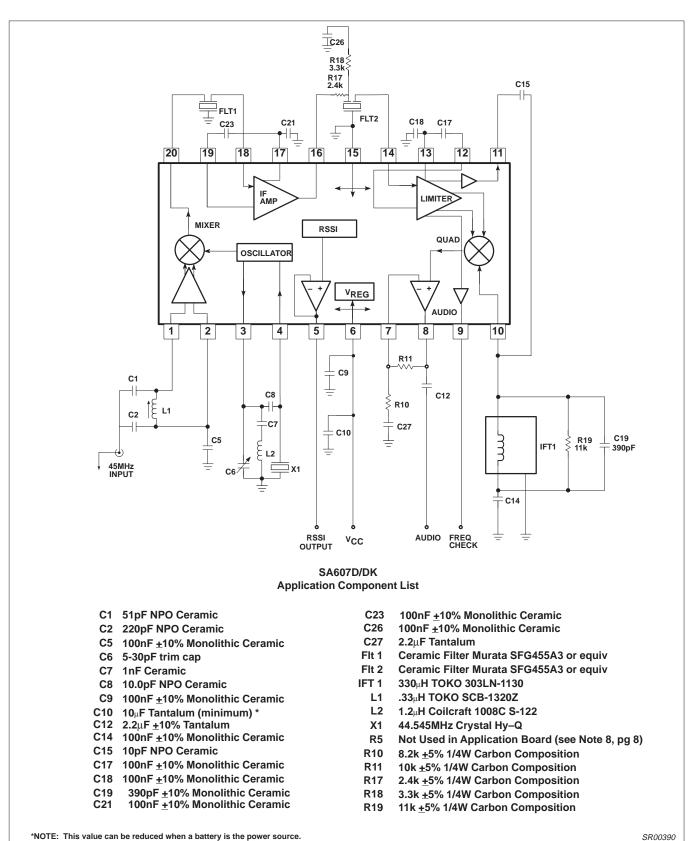


Figure 3. SA607 45MHz Test Circuit (Relays as shown)

### SA607



SR00390

#### Figure 4. SA607 45MHz Application Circuit

SA607

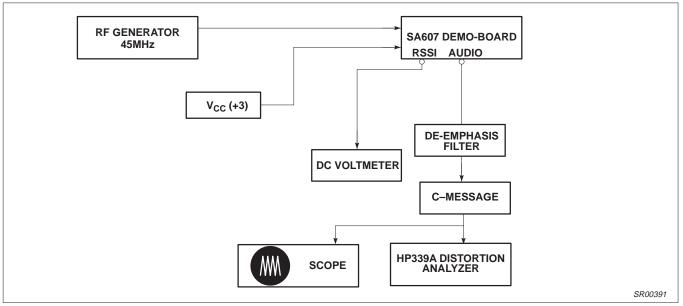


Figure 5. SA607 Application Circuit Test Set Up

#### NOTES:

- 1. C-message: The C-message and de-emphasis filter combination has a peak gain of 10 for accurate measurements. Without the gain, the measurements may be affected by the noise of the scope and HP339 analyzer. The de-emphasis filter has a fixed -6dB/Octave slope between 300Hz and 3kHz.
- 2. Ceramic filters: The ceramic filters can be 30kHz SFG455A3s made by Murata which have 30kHz IF bandwidth (they come in blue), or 16kHz CFU455Ds, also made by Murata (they come in black). All of our specifications and testing are done with the more wideband filter.
- 3. RF generator: Set your RF generator at 45.000MHz, use a 1kHz modulation frequency and a 6kHz deviation if you use 16kHz filters, or 8kHz if you use 30kHz filters.
- 4. Sensitivity: The measured typical sensitivity for 12dB SINAD should be  $0.35\mu$ V or -116dBm at the RF input.
- 5. Layout: The layout is very critical in the performance of the receiver. We highly recommend our demo board layout.
- 6. RSSI: The smallest RSSI voltage (i.e., when no RF input is present and the input is terminated) is a measure of the quality of the layout and design. If the lowest RSSI voltage is 500mV or higher, it means the receiver is in regenerative mode. In that case, the receiver sensitivity will be worse than expected.
- 7. Supply bypass and shielding: All of the inductors, the quad tank, and their shield must be grounded. A 10-15μF or higher value tantalum capacitor on the supply line is essential. A low frequency ESR screening test on this capacitor will ensure consistent good sensitivity in production. A 0.1μF bypass capacitor on the supply pin, and grounded near the 44.545MHz oscillator improves sensitivity by 2-3dB.
- R5 can be used to bias the oscillator transistor at a higher current for operation above 45MHz. Recommended value is 22kΩ, but should not be below 10kΩ.

SA607

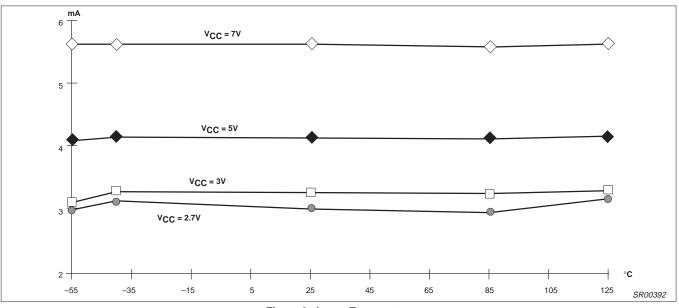


Figure 6. I<sub>CC</sub> vs Temperature

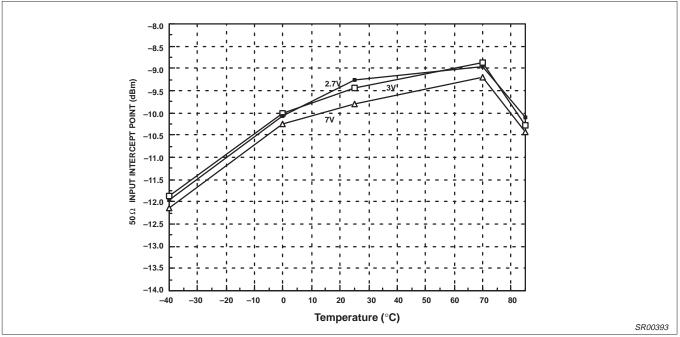


Figure 7. Third Order Intercept Point vs Supply Voltage

1997 Nov 07

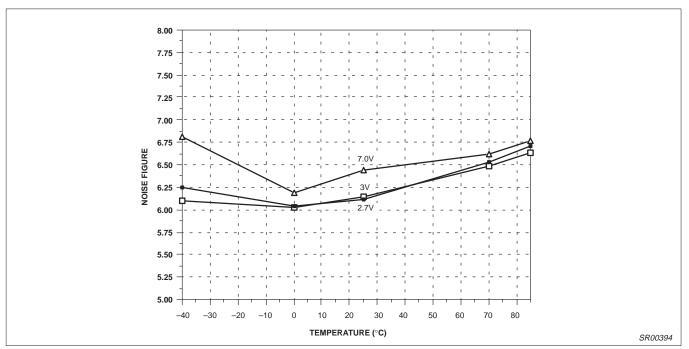


Figure 8. Mixer Noise Figure vs Supply Voltage

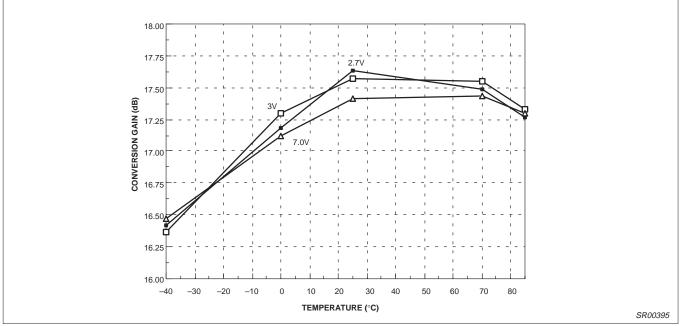


Figure 9. Conversion Gain vs Supply Voltage

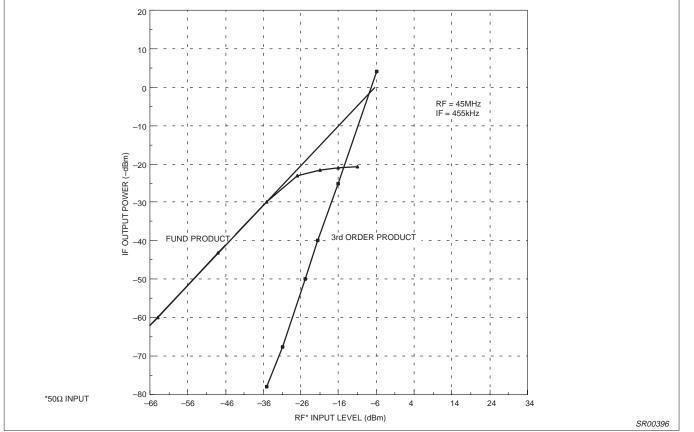


Figure 10. Mixer Third Order Intercept and Compression

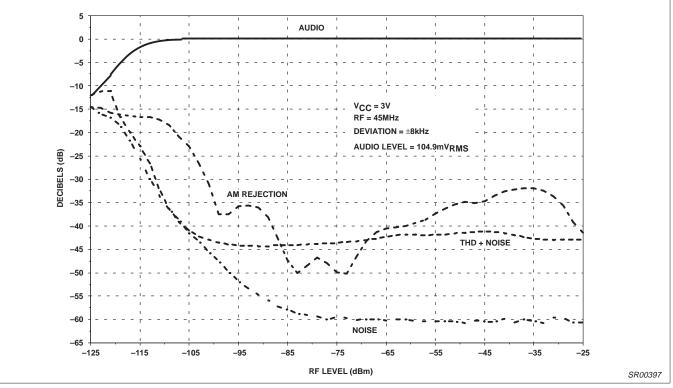


Figure 11. Sensitivity vs RF Level (–40°C)

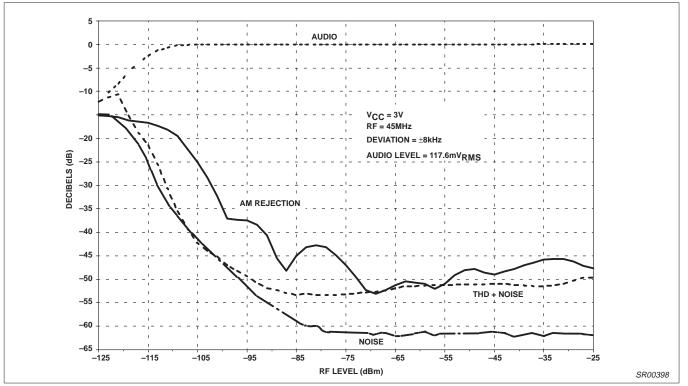


Figure 12. Sensitivity vs RF Level (+25°C)

SA607

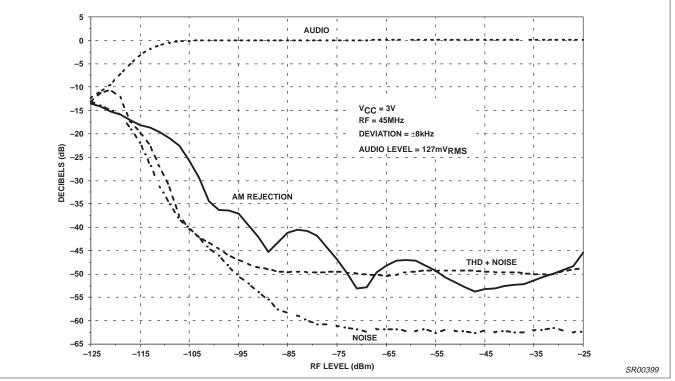


Figure 13. Sensitivity vs RF Level (Temperature 85°C)

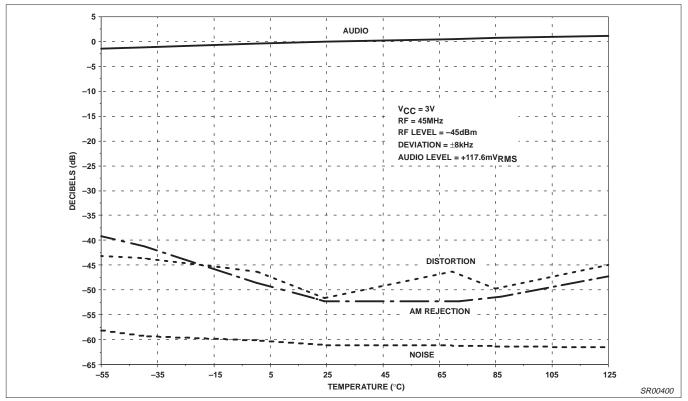
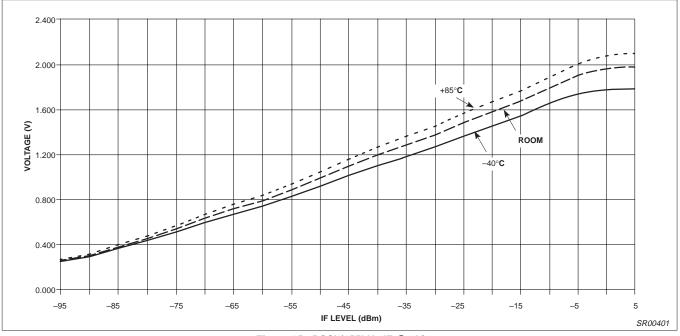
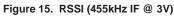


Figure 14. Relative Audio Level, Distortion, AM Rejection and Noise vs Temperature

1997 Nov 07







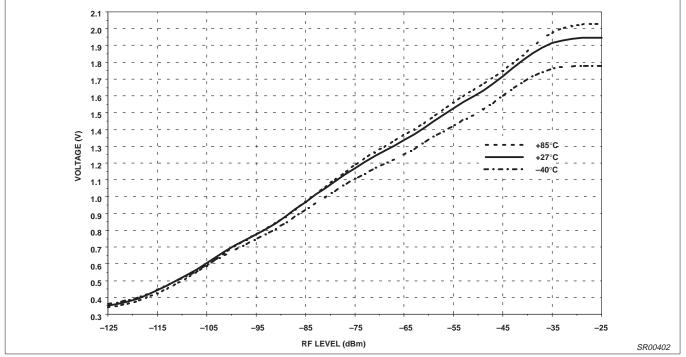


Figure 16. RSSI vs RF Level and Temperature -  $V_{CC}$  = 3V

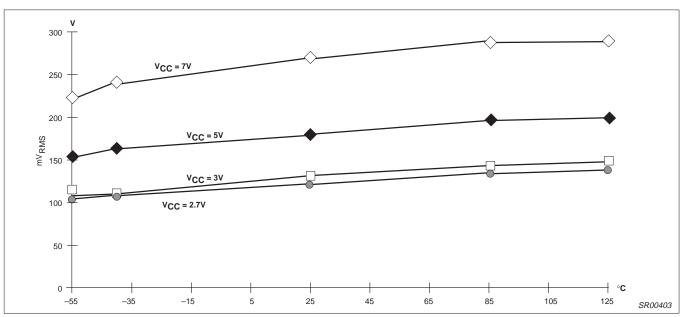


Figure 17. Audio Output vs Temperature

C2

L2

C7

X1

+

C10

R

Ŧ

۷

Ŧ

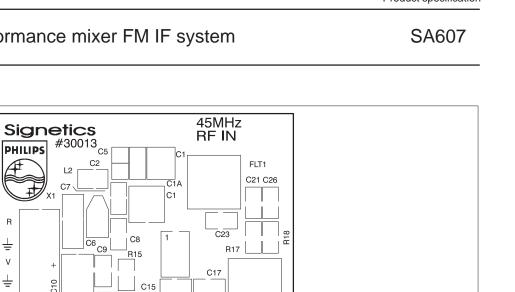
А

Ŧ

FC

Ŧ

607 Silk Screen



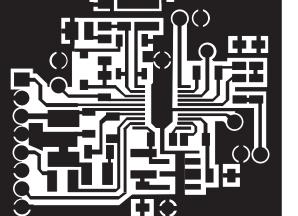
FLT2

C18

EVALUATION BOARD

R19 IFT1





C19

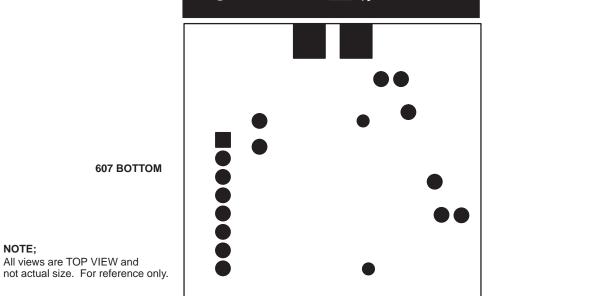
+R16

C14

C27

SA607DK

C12+



SR00404

#### Product specification

SA607

# Low voltage high performance FM IF system

# SO20: plastic small outline package; 20 leads; body width 7.5 mm SOT163-1 А Х = v 🕅 A $H_{F}$ 11 Q (A pin 1 index Π 10 detail X 0 w е bp 10 mm 5 0 scale DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A2	Α3	<b>b</b> р	с	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	У	z <sup>(1)</sup>	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8 <sup>0</sup>
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.42 0.39	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

#### Note

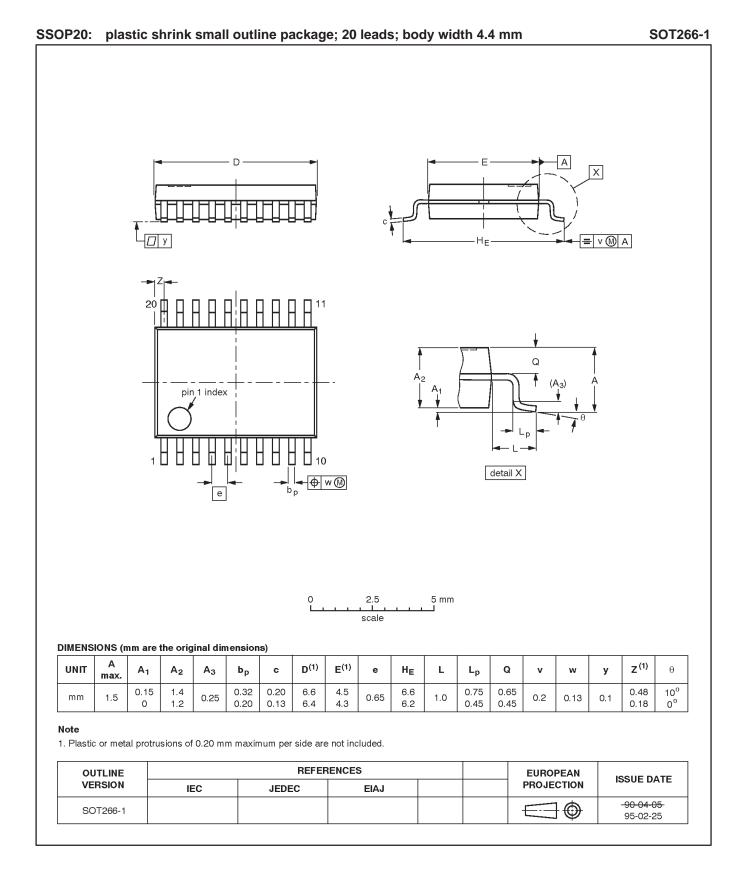
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC EIAJ			PROJECTION	1350E DATE	
SOT163-1	075E04	MS-013AC				<del>-92-11-17</del> 95-01-24	

#### Product specification

SA607

### Low voltage high performance FM IF system



### SA607

DEFINITIONS								
Data Sheet Identification	Product Status	Definition						
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.						
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.						
Product Specification	Full Production	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.						

Philips Semiconductors and Philips Electronics North America Corporation reserve the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified. Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

#### LIFE SUPPORT APPLICATIONS

Philips Semiconductors and Philips Electronics North America Corporation Products are not designed for use in life support appliances, devices, or systems where malfunction of a Philips Semiconductors and Philips Electronics North America Corporation Product can reasonably be expected to result in a personal injury. Philips Semiconductors and Philips Electronics North America Corporation customers using or selling Philips Semiconductors and Philips Electronics North America Corporation so at their own risk and agree to fully indemnify Philips Semiconductors and Philips Electronics North America Corporation for any damages resulting from such improper use or sale.

Philips Semiconductors 811 East Arques Avenue P.O. Box 3409 Sunnyvale, California 94088–3409 Telephone 800-234-7381 © Copyright Philips Electronics North America Corporation 1997 All rights reserved. Printed in U.S.A.

Let's make things better.





This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.